



# Product Change Notification

**Change Notification #:** 118652-00  
**Change Title:** Select Intel® Optane™ SSD P1600X Series PCN 118652-00, Product Marking, Label PCB Intel logo change and Label Intel logo change  
**Date of Publication:** November 05, 2021

**Key Characteristics of the Change:**  
Product Marking, Label

## Forecasted Key Milestones:

<b>Date Customer Must be Ready to Receive Post-Conversion Material</b>	December 6, 2021
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## Description of Change to the Customer:

The Intel SKUs listed in the products affected table will have the following changes.

- 1) PCB silkscreen for Optane logo and Intel logo.

Before

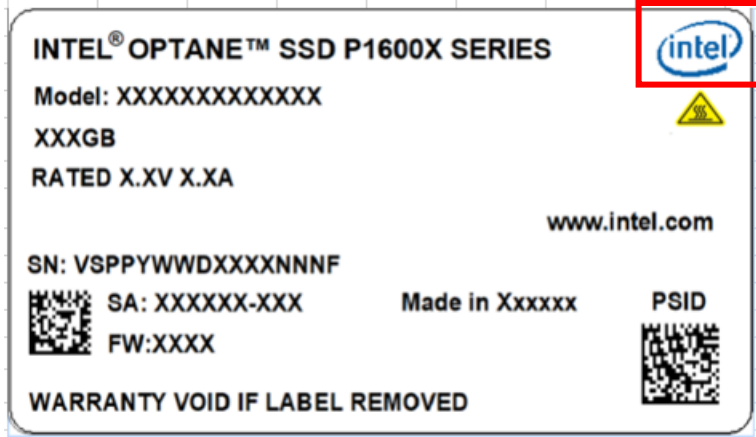


After



2) SSD label for Intel logo

Before



After



**Customer Impact of Change and Recommended Action:**

Intel anticipates no impact to customers. Please contact your local Intel Field Sales Rep if you have any further questions about these changes

**Products Affected/Intel Ordering Codes:**

Marketing Name	Product Code	MM#
Intel® Optane™ SSD P1600X Series (58GB, M.2 80mm PCIe 3.0 x4, 3D XPoint™) Generic Single Pack	SSDPEK1A058GA01	99A9GX
Intel® Optane™ SSD P1600X Series (118GB, M.2 80mm PCIe 3.0 x4, 3D XPoint™) Generic Single Pack	SSDPEK1A118GA01	99AGG3
Intel® Optane™ SSD P1600X Series (58GB, M.2 80mm PCIe 3.0 x4, 3D XPoint™) Generic 100 Pack	SSDPEK1A058GA	99AJ1F
Intel® Optane™ SSD P1600X Series (118GB, M.2 80mm PCIe 3.0 x4, 3D XPoint™) Generic 100 Pack	SSDPEK1A118GA	99AJ1G

**PCN Revision History:**

**Date of Revision:**  
November 05, 2021

**Revision Number:**  
00

**Reason:**  
Originally Published PCN



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## 118652-00

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**Should you have any issues with the timeline or content of this change, please contact the Intel Representative(s) for your geographic location listed below. No response from customers will be deemed as acceptance of the change and the change will be implemented pursuant to the key milestones set forth in this attached PCN.**

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